

SilSo SE2014 2 part encapsulation and potting silicone

Description

This is a 2-component, silicone elastomer system specially designed for electronic potting and encapsulation applications. It offers good protection against chemicals, environmental contamination, mechanical shock, vibration and impact damage. It can be employed in areas where low flammability is a prerequisite. The cured elastomer can be repaired. The component parts have relatively low viscosities and are readily mixed either by hand or machine.

Key Features

- Light weight and low density
- Long pot life
- UL recognised in file number E334038
- Very high dielectric strength

Application

Coating for the umbilical cable ROV underwater remotely operated vehicles

Use and Cure Information

IMPORTANT:

The 'A' part of the product contains the platinum catalyst, great care should be taken when using automatic dispensing equipment. Please ensure that it is not contaminated by residual hydride containing rubber in the dispensing equipment, as curing will result. If in doubt, it's advised to thoroughly purge the equipment with a suitable hydrocarbon solvent or silicone fluid.

Mixing

Both the 'A' and 'B' parts should be well stirred to ensure the material is uniform and any settled the fillers have been remixed. Place the required amount of 'A' and 'B' parts by weight at the mix ratio shown opposite, in a clean plastic or metal container of approximately 3 times their volume, and mix until the colour of the mixture is uniform. For best results, we recommend degassing. Degas by intermittent evacuation, the larger volume of the mixing vessel helps prevent overflow during this operation. In the case of automatic dispensing with static mixing head, the two components should be degassed before processing. Recommended vacuum conditions are 30-50 mbar intermittently over 5-10 minutes. Cast the mixture either by gravity or pressure injection.

Inhibition of Cure

Great care must be taken when handling and mixing all addition cured silicone elastomer systems, ensuring that all the mixing tools (vessels and spatulas) are clean and constructed in materials which do not interfere with the curing mechanism. The cure of the rubber can be inhibited by the presence of compounds of nitrogen, sulphur, phosphorus and arsenic; organotin catalysts and PVC stabilizers; epoxy resin catalysts and even contact with materials containing certain of these substances e.g. moulding clays, sulphur vulcanised rubbers, condensation cure silicone rubbers, onion and garlic.

Curing Conditions

The data offers a guide to the rate of cure at various temperatures, mixing of the components at temperatures between 15 and 25°C is recommended to ensure adequate pot life for degassing and handling. The pot life can be extended to several hours by chilling the components before mixing.

It is important to check the compatibility in preliminary tests if unknown substrates are used.

Health & Safety

Safety Data Sheets available on request.

Packaging

CHT Encapsulants are available in a variety packaging including bulk containers. Please contact our sales department for more information.

Property

Uncured Product

Appearance			Viscous liquid
Color A			Off white
Color B			Green
Cure Profile			>23°C
Cure Type			Addition
Density A	BS ISO 2781		0.79
Density B	BS ISO 2781		0.77
Mix Ratio By Weight			1:1
Pot Life hrs at 23°C/73°F			6 hours
Rheology			Liquid
Self Bonding			No
Viscosity A	Brookfield		12200 cP
Viscosity B	Brookfield		7200 cP
Viscosity Mixed	Brookfield		10000 cP

Cured Product

177°C for 17 minutes

Color			Green
Density	BS ISO 2781		0.73 g/cm3
Elongation at Break	ISO 37		54 %
Hardness Shore A	ASTM D 2240-95		67
Linear Coefficient of Thermal Expansion (ppm/°C)			218 ppm/°C
Max Working Temp			200 °C / 392 °F
Min Working Temp			-55 °C / -67 °F
Tensile Strength	ISO 37		2.7 N/mm2 / 392 psi
Thermal Conductivity			0.14 W/mK
Volume Coefficient of Thermal Expansion (ppm/°C)			818 ppm/°C

Electrical Properties

Dielectric Constant	ASTM D-150		2.29
Dielectric Strength kV/mm	ASTM D-149		32.1 kV/mm / 816 V/mil
Dissipation Factor	ASTM D-150		0.00174
Volume Resistivity (Ohms cm)	ASTM D-257		1E+15 ohms cm

Storage

Max Storage Temperature			30 °C / 86 °F
Shelf Life			12 mths

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Revision Date	21 Sep 2022
Revision No	2
Download Date	18 May 2024